


PCN Number:	20191209001	PCN Date:	Dec. 12, 2019
Title:	Datasheet for SN74LVC1G126-Q1		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process
Notification Details			
Description of Change:			
<p>Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.</p>			
		SN74LVC1G126-Q1 <small>SCES467C – JULY 2003 – REVISED OCTOBER 2019</small>	
Changes from Revision B (April 2008) to Revision C			
			Page
• Updated document to new TI data sheet format			1
• Removed Ordering Information table			1
• Added <i>Applications</i> list, <i>Device Information</i> table			1
• Changed 1.65-V to 3.6-V V _{CC} to 1.65-V to 5-V V _{CC} operation			1
• Added DRY package			3
• Added ESD Ratings table			4
• Changed MAX operating temperature to 125°C in <i>Recommended Operating Conditions</i> table			5
• Added <i>Thermal Information</i> table			5
• Added <i>Feature Description</i> section,			10
• Added <i>Device Functional Modes</i> section			10
• Added <i>Application and Implementation</i> section,			11
• Added <i>Power Supply Recommendations</i> section			12
• Added <i>Layout</i> section			12
• Added <i>Device and Documentation Support</i> section and <i>Mechanical, Packaging, and Orderable Information</i> section			13
The datasheet number will be changing.			
Device Family	Change From:	Change To:	
SN74LVC1G126-Q1	SCES467B	SCES467C	
These changes may be reviewed at the datasheet links provided.			
http://www.ti.com/product/SN74LVC1G126-Q1			
Reason for Change:			
To accurately reflect device characteristics.			
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):			
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.			
Changes to product identification resulting from this PCN:			
None.			

Product Affected:			
1P1G126QDBVRQ1	1P1G126QDRYRQ1		

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

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